

Test Report issued under the responsibility of:



TEST REPORT

IEC 60950-1

Information technology equipment – Safety – Part 1: General requirements

 Report Number.
 1510058STO-001

 Date of issue
 29 October 2015

Total number of pages...... 85 pages

Applicant's name...... TDK-Lambda Corporation

Address: 2704-1 Settaya-machi, Nagaoka-shi, Niigata, 940-1195 JAPAN

Test specification:

Standard.....: IEC 60950-1:2005 (Second Edition) + Am 1:2009 + Am 2:2013

Test procedure CB Scheme

Non-standard test method: N/A

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Testing procedure and testing location:				
\boxtimes	CB Testing Laboratory:	Intertek Semko AB		
Testing location/ address:		Torshamnsgatan 43, P.O. Box 1103, SE-164 22 Kista, SWEDEN		
	Associated CB Testing Laboratory:			
Testi	ng location/ address:			
Test	ed by (name + signature):	Bedran Nergiz	Beden Megin	
Appr	oved by (name + signature):	Anna Karin Cedergren	Redergren	
	Testing procedure: TMP/CTF Stage 1:		V	
Testing location/ address:				
Test	ed by (name + signature):			
Appr	oved by (name + signature):			
	Testing procedure: WMT/CTF Stage 2:			
Testing location/ address:			6	
Test	ed by (name + signature):			
Witn	essed by (name + signature):			
Appr	oved by (name + signature):			
	Testing procedure: SMT/CTF Stage 3 or 4:			
Testing location/ address:				
Tested by (name + signature):				
Witnessed by (name + signature):				
Appr	oved by (name + signature):			
Supe	ervised by (name + signature):			

S 114 14-05 Strömberg 214248

Summary of testing: Tests performed (name of test and test clause): See test report Testing location: See page 2

Summary of compliance with National Differences:

☐ The product fulfils the requirements of EN 60950-1:2006+A11:2009+A1:2010+A12:2011+A2:2013. Group- and national differences for the CENELEC countries have been considered during the testing.

Copy of marking plate: (example)

The artwork below may be only a draft. The use of certification marks on a product must be authorized by the respective NCBs that own these marks.



Models included within the scope of this report						
Model	Input, DC		Outpu	-		
-	V	A _{max}	V	A _{max}	O/P Power	
PAH75D48-5033	36-76	2.86	3.3	15	75	
	-	-	5.0	15	75	
PAH75D48-3325	36-76	2.86	2.5	15	60	
	-	-	3.3	15	60	
PAH75D48-3318	36-76	2.86	1.8	15	50	
	-	-	3.3	15	50	
PAH75D48-2518	36-76	2.86	1.8	15	45	
	-	-	2.5	15	45	
PAH75D24-5033	18-36	5.7	3.3	15	75	
	-	-	5.0	15	75	
PAH75D24-3325	18-36	5.7	2.5	15	60	
	-	-	3.3	15		

Maximum output power for each model, not exceed the values tabulated above. Maximum baseplate temperature not exceeds 100°C.

Model Differences:

Model PAH75D48-5033 is the base Model.

Models PAH75D48-3325, PAH75D48-3318, PAH75D48-2518 are similar to Model PAH75D48-5033, differing only in the output ratings and Transformer T102. Models with suffix /Z are similar to the basic models, differing only in the provision of modified output trim circuitry, which is not safety related.

Models PAH75D24-5033 and PAH75D24-3325 are similar to Models PAH75D48-5033 and PAH75D48-3325, respectively, differing only in various primary component values and transformer windings, for operation at an input voltage of 24Vdc, which are not safety related.

Suffix options PAH75D48-5033 /x where x is any suffix below.

Suffix	On/Off Control	Pin Ler	ngth OVP	OTP	Stud
-	Negative	5.08	Manual Reset	Auto Reset	with Treads
Р	Positive	N/A	N/A	N/A	N/A
2	N/A	2.79	N/A	N/A	N/A
3	N/A	3.68	N/A	N/A	N/A
Н	N/A	N/A	N/A	Manual Res	set N/A
V	N/A	N/A	Auto Restart	N/A	N/A
T	N/A	N/A	N/A	N/A	without threads

Test item particulars:			
Equipment mobility:	[] movable [] hand-held [] transportable [] stationary [x] for building-in [] direct plug-in		
Connection to the mains:	[] pluggable equipment [] type A [] type B [x] permanent connection [] detachable power supply cord [] non-detachable power supply cord [] not directly connected to the mains		
Operating condition:	[x] continuous [] rated operating / resting time:		
Access location:	[] operator accessible [] restricted access location [x] for building into a host equipment		
Over voltage category (OVC):	[] OVC I [x] OVC II [] OVC III [] OVC IV [] other:		
Mains supply tolerance (%) or absolute mains supply values:	Not applicable. Voltage range 18-36Vdc max or 36-76Vdc max.		
Tested for IT power systems:	[] Yes [x] No		
IT testing, phase-phase voltage (V)	N/A		
Class of equipment:	[x] Class I [] Class II [] Class III [] Not classified		
Considered current rating of protective device as part of the building installation (A)	16		
Pollution degree (PD)	[] PD 1 [x] PD 2 [] PD 3		
IP protection class:	IPX0		
Altitude during operation (m)	<2000		
Altitude of test laboratory (m)	<2000		
Mass of equipment (kg)	<0.100		
Possible test case verdicts:			
- test case does not apply to the test object:	N/A		
- test object does meet the requirement:	P (Pass)		
- test object does not meet the requirement:	F (Fail)		
Testing:	See "General remarks" below		
Date of receipt of test item:	-		
Date (s) of performance of tests:	See "General remarks" below		
General remarks:			
"(See Enclosure #)" refers to additional information appended to the report. "(See appended table)" refers to a table appended to the report. The test results and all data in this report are derived from previously issued Test Report No. 1218094 dated 3 September 2012, issued by Intertek Semko AB. A new report has been issued due to update of the standard IEC 60950-1, to include Am 2: 2013. No additional test has been conducted.			
Throughout this report a \square comma / \boxtimes point is used as the decimal separator.			

Manufacturer's Declaration per sub-clause 4.2.5 of IECEE 02:					
The application for obtaining a CB Test Certificate includes more than one factory location and a declaration from the Manufacturer stating that the sample(s) submitted for evaluation is (are) representative of the products from each factory has been provided			✓ Yes☐ Not applicable:		
When differences exist; they	shall be identified in t	the "C	General product informa	ation" s	ection.
Name and address of factories:			TDK-Lambda (Malaysia) Sdn. Bhd. PLO33 Locked Bag No. 110 Kawasan Perindustrian Senai 81400 Senai Johor, Darul Takzim, MALAYSIA TDK-Lambda Corporation Nagaoka Technical Center 2704-1 Settaya-machi, Nagaoka, Niigata 940-1195 JAPAN Wuxi TDK-Lambda Electronics Co., Ltd. No.6 Xing Chuang Er lu Wuxi Jiangsu, 214028 CHINA		
Abbreviations used in the - normal conditions	-	- sinc	gle fault conditions		S.F.C
 functional insulation double insulation between parts of opposite 	OP	- bas	ic insulation plementary insulation		BI SI
polarity Indicate used abbreviations	_	- rein	forced insulation		RI

This Test Report replaces previously issued, see table below. $\ensuremath{\mathbf{REVISION\ TABLE}}$

Date	Report ref.	Clause	Modification of the appliance
29 Oct. 2015	1510058STO-001	-	Basic Test Report

General Product Information:

- These products shall be installed in accordance with the requirements of IEC 60950-1, EN 60950-1 for the end use application. The DC to DC converters were tested with the heatsink mounted below the baseplate of the converters (worst case).
- The equipment has been evaluated for use in a pollution Degree 2 environment.
- Consideration shall be given to measuring the temperature on power electronic components, inductors and transformer windings when the power supply is installed in the end use equipment. Transformer T102 employs a Class F (155) insulation system and T1 employs a Class B (130) insulation system. Transformer T101 is of the planar type, which employs printed wiring and a copper strip as primary and secondary windings. The copper strip is wrapped with R/C OANZ2 polyimide (Kapton) tape. The PWB's and polyimide tape are rated 130°C min. It must be ensured that the baseplate temperature does not exceed 100 degrees Celsius. This temperature limit governs the working ambient temperature.
- The input to the units must be isolated from the mains by reinforced insulation in accordance with EN60950-1 and IEC60950-1 in order to maintain a SELV output. Due to the potential non-SELV voltages at the input of the PAH75D48 Series, the input to these units must be considered hazardous secondary voltage. This is not applicable to the PAH75D24 Series. Outputs were determined to be SELV.
- This power supply shall be properly bonded to earth ground in the end use product as this unit was investigated for Class I construction.

The recommended input fuse rating within the instructions, and the fuse used for testing is as follows: PAH75D24 = F10AH, 250 V PAH75D48 = F5AH, 250V.

- The breaking capacity and voltage rating are subject to the end use application.
- These products were assessed for basic insulation at working voltage between input and output. All fault testing across the barriers was conducted under all input and output earth combinations.
- The input and output connectors are not acceptable for field wiring connections and are only intended for connection to a PCB inside the end use equipment.

Testing Environment:

- An ambient temperature in the range 15°C to 30°C
- A relative humidity in the range 25% to 75%
- An air pressure in the range 86 kPa to 106 kPa